发TRANSMITTAL OF FORMAL DRAWINGS FIS920040004US1 (17368) Brian W. Messenger, et al. ation Of: Application No. Filing Date Confirmation No. Examiner Customer No. Group Art Unit 10/710,738 July 30, 2004 Unassigned 23389 Unassigned Unassigned MANUFACTURABLE RECESSED STRAINED RSD STRUCTURE AND PROCESS FOR ADVANCED CMOS Invention: Address to: **Commissioner for Patents** P.O. Box 1450 Alexandria, VA 22313-1450 Transmitted herewith are: 3 sheets of formal drawing(s) for this application. \mathbf{X} Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c). Dated: February 15, 2005 Signature Leslie S. Szivos, Ph.D. Registration No. 39,394 I certify that this document and attached formal drawings are being deposited on 02/15/05 with the

I certify that this document and attached formal drawings are being deposited on 02/15/05 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Compussioner for Patents, P.O. Box 1450, Alexandria, VA 22213-1450

Signature of Person Mailing Correspondence

Leslie S. Szivos, Ph.D.

Typed or Printed Name of Person Mailing Correspondence